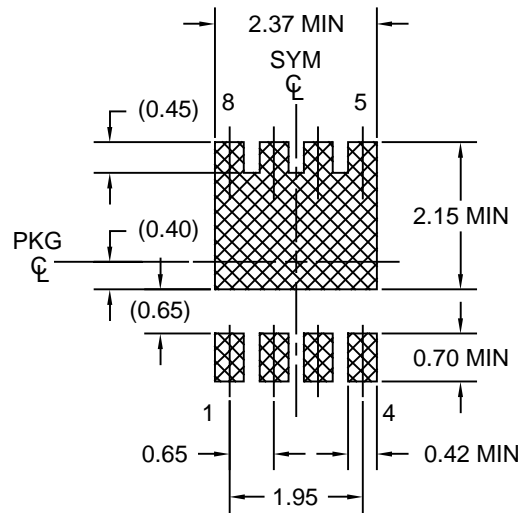
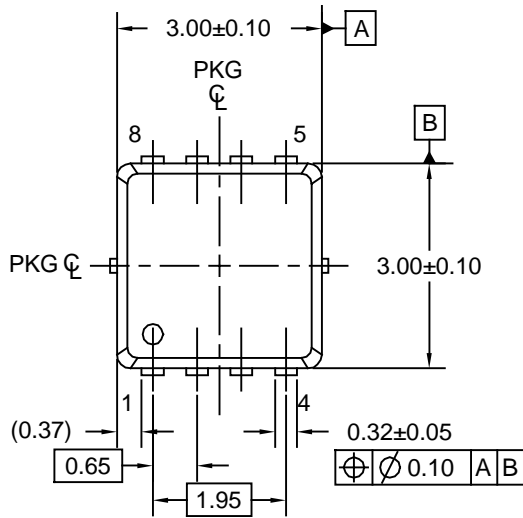
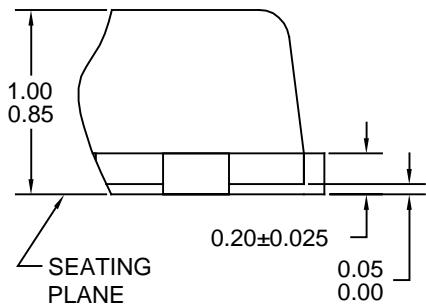
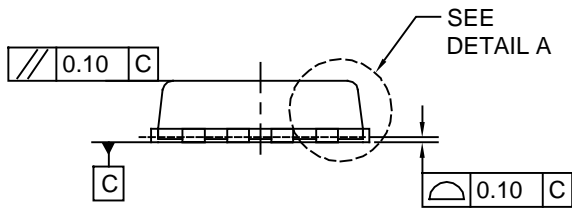


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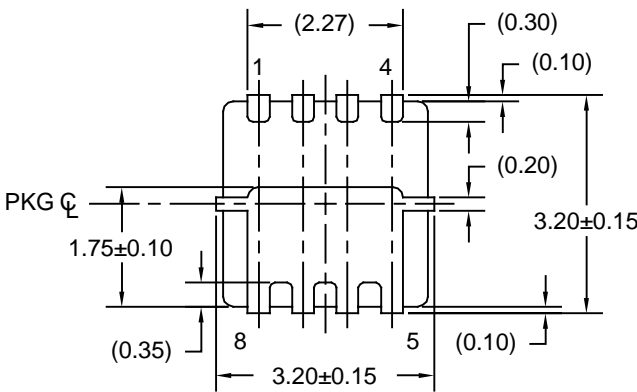
REVISIONS				
LR	DESCRIPTION	ECN	DATE	BY/APPRO
A	RELEASE TO DOCUMENT CONTROL	CB22702	23JUL2002	MRG/EAC
B	CHG DWG TITLE FR "JEDEC MO229, 3mm SQUARE" TO "DUAL, NON JEDEC VERSION, 3.3mm SQUARE, CHG NOTE A) FR JEDEC MO229 TO NO JEDEC STANDARD REF."	CB23902	2AUG2002	MRG/EAC
1	CHG DWG # FROM MLP08L TO MLP08L TO ELIMINATE DUPLICATION IN DRAWING NUMBER ASSIGNMENT. REVISION LEVEL CHANGED TO NUMBER	ECN-MKT-MLP08L1	14/09/06	H.ALLEN



LAND PATTERN RECOMMENDATION



DETAIL A
SCALE: 3:1



- NOTES: UNLESS OTHERWISE SPECIFIED
- A) NO JEDEC STANDARD REFERENCE AS OF JULY 2002.
 - B) ALL DIMENSIONS ARE IN MILLIMETERS.
 - C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
 - D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

MLP08Lrev1

APPROVALS	DATE	FAIRCHILD SEMICONDUCTOR™	
DRAWN: H.ALLEN	14/9/06	PENANG MALAYSIA	
CHECKED: J. CHAN		8LD, MLP, DUAL, NON JEDEC VERSION, MICROFET, 3.3 mm SQUARE	
APPROVED:		SCALE: 1:1	REV: 1
		FORMERLY: N/A	SHEET: 1 OF 1